



Pb-free
HEAT



DNK1101M

Surface Mount Type/
High-output IRED for Automotive

Features

| | |
|-------------------------|--|
| Package | 10.2 x 6.0 mm (h=5.5 mm) type, Water clear epoxy |
| Product features | <ul style="list-style-type: none">• Outer Dimension 10.2 x 6.0 x 5.5mm (L x W x H)• Big Lenz Type• Wide operation temperature range. Storage Temperature : -40 ~ 120 Operating Temperature : -30 ~ 95• High Total Output Power : 22mW TYP. (I_F=50mA)• Operation at 50mA is possible at 85 .• Lead-free soldering compatible• RoHS compliant |
| Peak Wavelength | 870nm |
| Half Intensity Angle | x = 38 deg., y = 38 deg. |
| Die materials | GaAIAs |
| Rank grouping parameter | Sorted by radiant intensity per rank taping |
| Assembly method | Auto pick & place machine (Auto Mounter) |
| Soldering methods | Reflow soldering Please refer to Soldering Conditions about soldering. |
| Taping and reel | 900pcs per reel in a 24mm width tape. (Standard) Reel diameter: 330mm |
| ESD | 2kV (HBM) |

Recommended Applications

Automotive (Camera of Door Mirror, Camera of Crew Detection, Camera of Driver Watch, Rear Head Phone, Back Monitor, Various Sensors)



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Absolute Maximum Ratings

(Ta=25)

| Item | Symbol | Absolute Maximum Ratings | Unit |
|------------------------------------|------------------|--------------------------|------|
| Power Dissipation | Pd | 170 | mW |
| Forward Current | Ta=60 | 120 | mA |
| | Ta=95 | 40 | |
| Pulse Forward Current ¹ | I _{FRM} | 1,200 | mA |
| Derating (Ta=60 or higher) | I _F | 2.29 | mA/ |
| | I _{FRM} | 22.90 | mA/ |
| Reverse Voltage | V _R | 5 | V |
| Operating Temperature | T _{opr} | -30 ~ +95 | |
| Storage Temperature | T _{stg} | -40 ~ +120 | |

¹ I_{FRM} Measurement condition : Pulse Width 100 μ s, Duty 1/100

Electro-Optical Characteristics

(Ta=25)

| Item | Conditions | Symbol | Characteristics | | Unit |
|-----------------------|--|-------------------|-----------------|--------|-------|
| | | | MIN. | TYP. | |
| Forward Voltage | I _F =50mA | V _F | MIN. | 1.3 | V |
| | | | TYP. | 1.5 | |
| | | | MAX. | 1.7 | |
| Pulse Forward Voltage | I _{FRM} =500mA | V _{FM} | MAX. | 3.4 | V |
| Reverse Current | V _R =5V | I _R | MAX. | 100 | μ A |
| Radiant Intensity | I _F =50mA | I _E | MIN. | 20 | mW/sr |
| | | | TYP. | 35 | |
| | | | MAX. | (60) | |
| Total Output Power | I _F =50mA | P _o | TYP. | 22 | mW |
| Peak Wavelength | I _F =50mA | λ _p | TYP. | 870 | nm |
| Spectral Half-width | I _F =50mA | | TYP. | 45 | nm |
| Half Intensity Angle | I _F =50mA | 2θ _{1/2} | TYP. | 38(x) | deg. |
| | | | | 38(y) | |
| Cut-off Frequency | I _F =50mA _{DC} ±5mA, -3db from 1MHz | f _c | MIN. | (40) | MHz |
| | | | TYP. | 55 | |
| Response Time | I _F =50mA | tr/ta | TYP. | 7/7 | ns |



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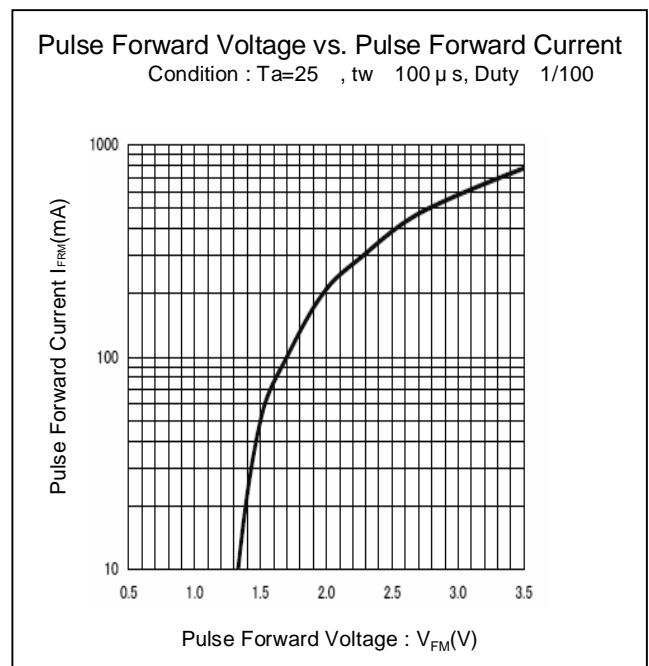
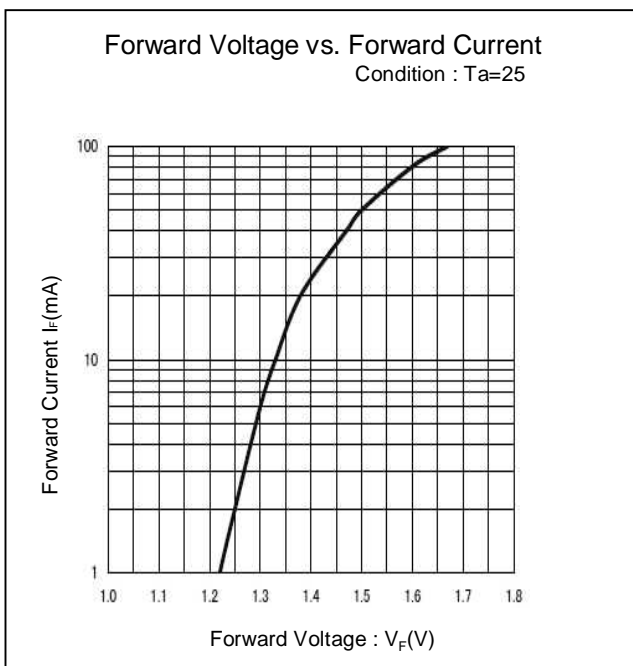
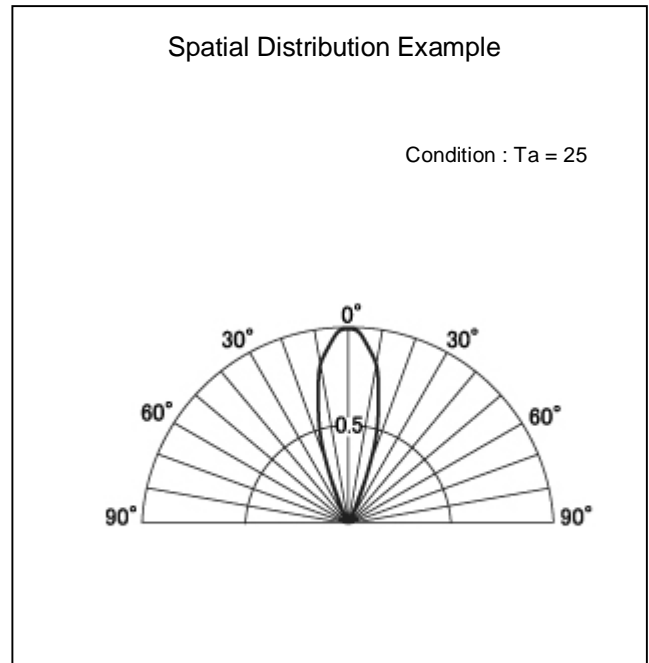
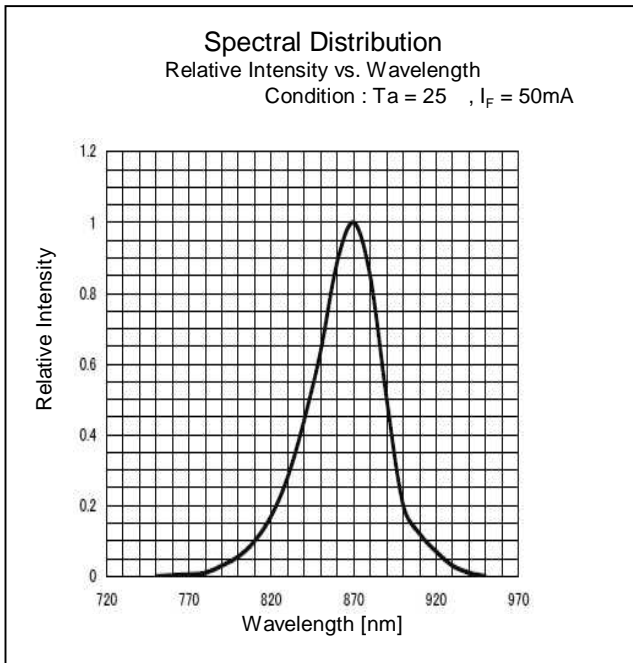
Radiant Intensity Rank

(Ta=25)

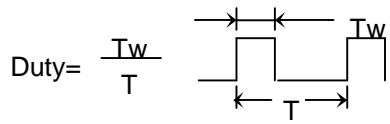
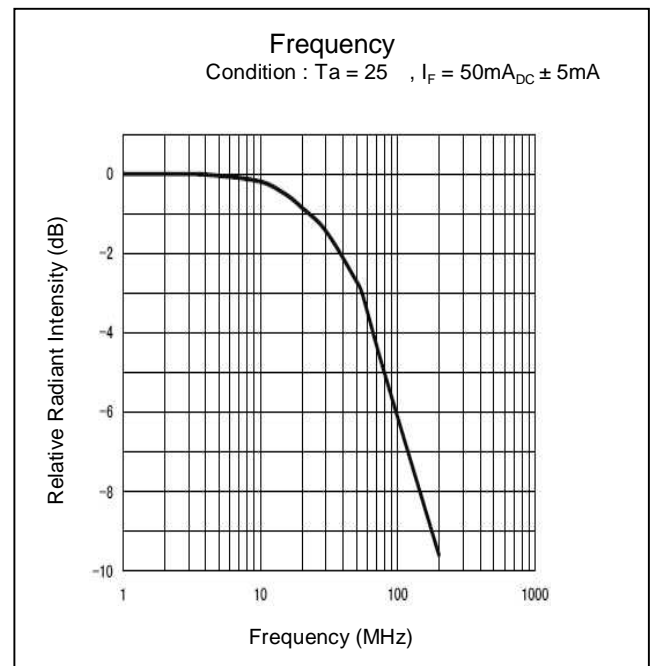
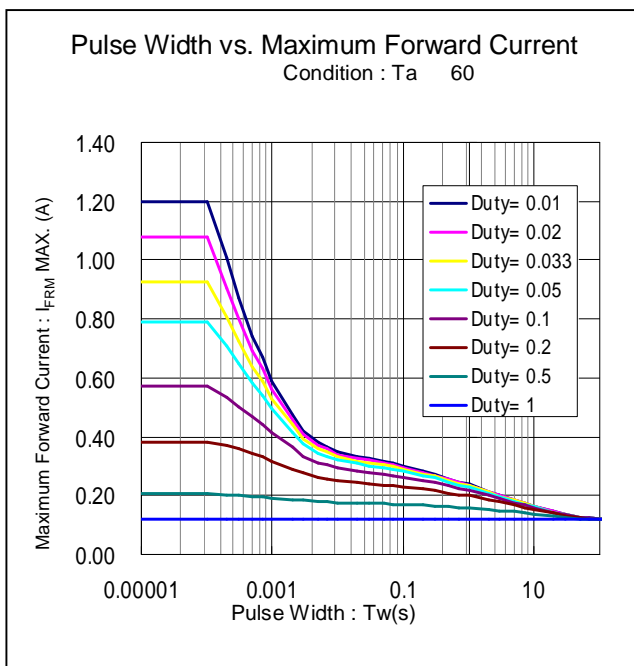
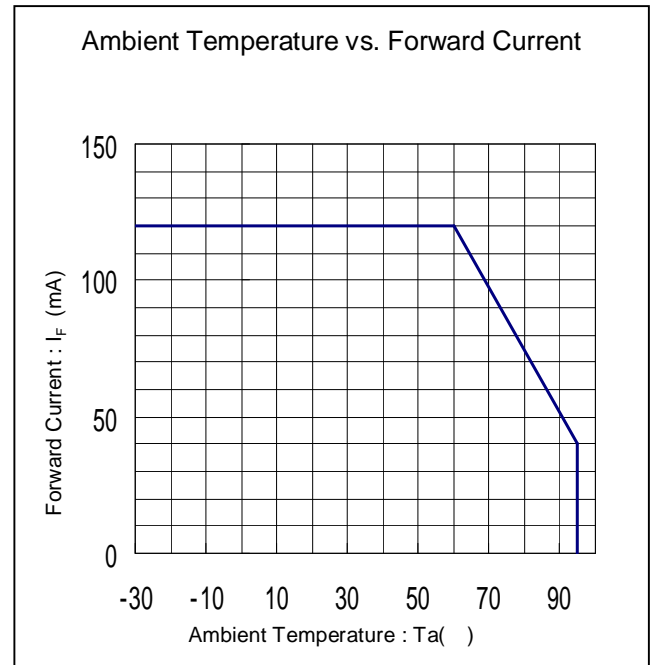
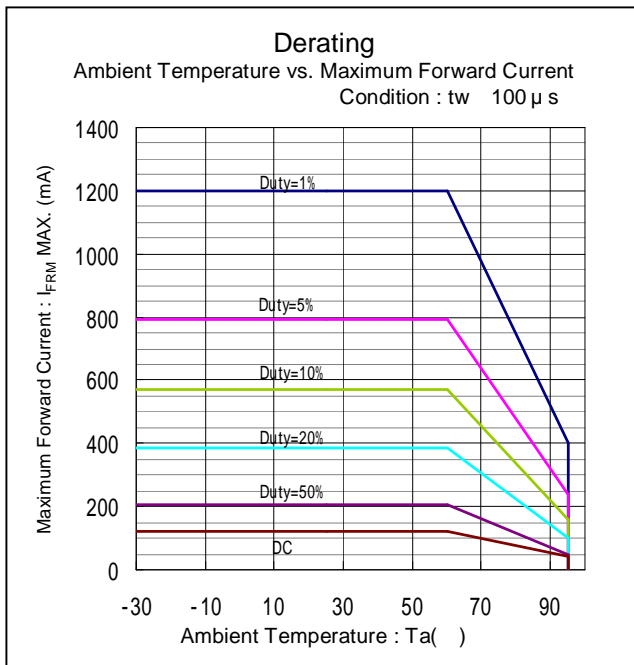
| Rank | I _E (mW/sr) | | Condition |
|------|------------------------|------|-----------------------|
| | MIN. | MAX. | |
| A | 20 | 35 | I _F = 50mA |
| B | 30 | 45 | |
| C | 40 | (60) | |

Please contact our sales staff concerning rank designation.

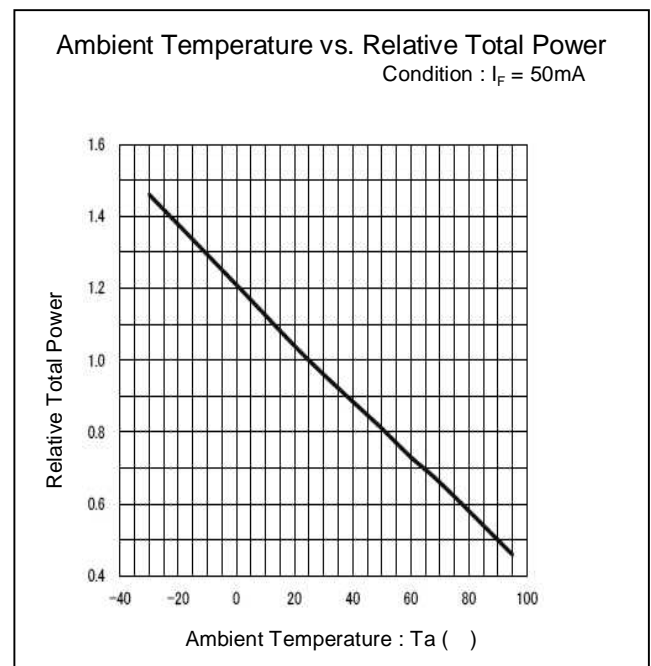
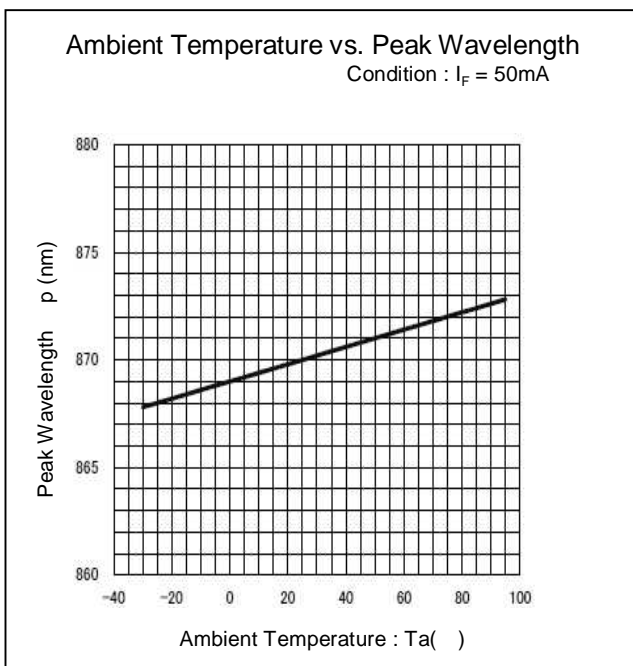
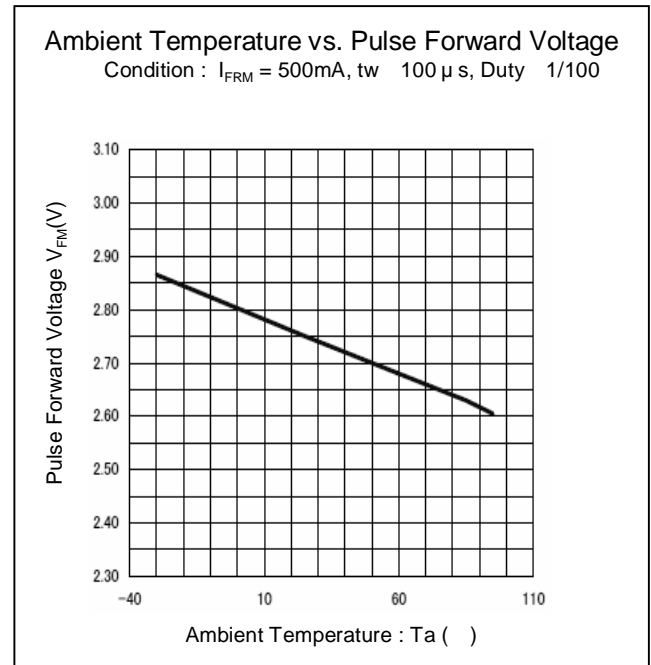
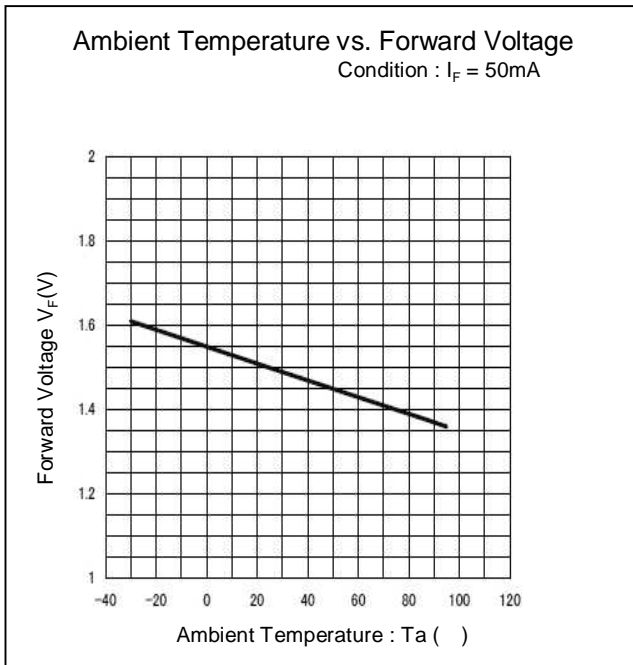
Technical Data



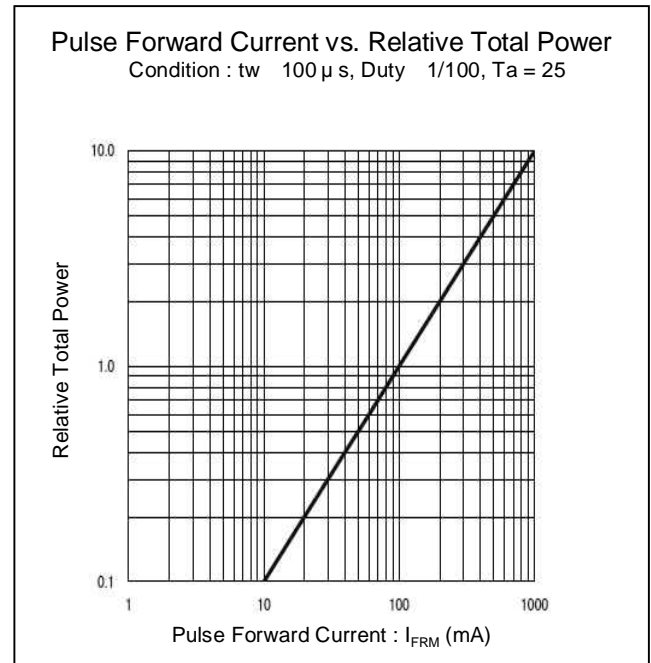
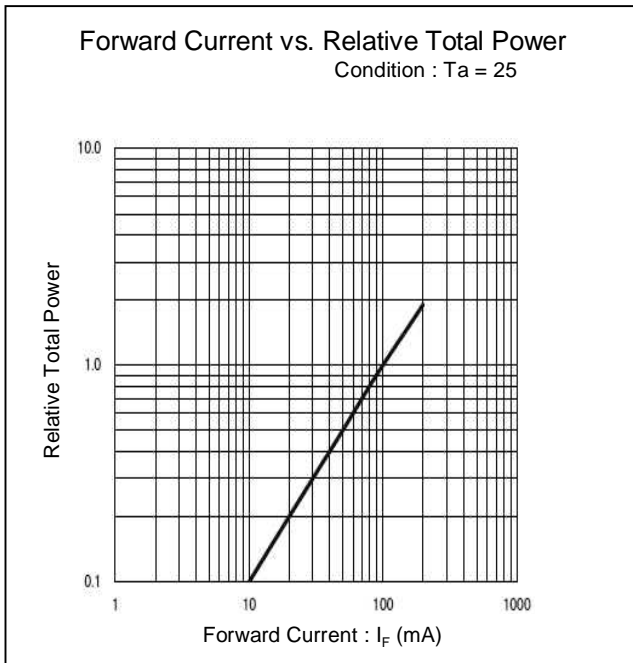
Technical Data



Technical Data



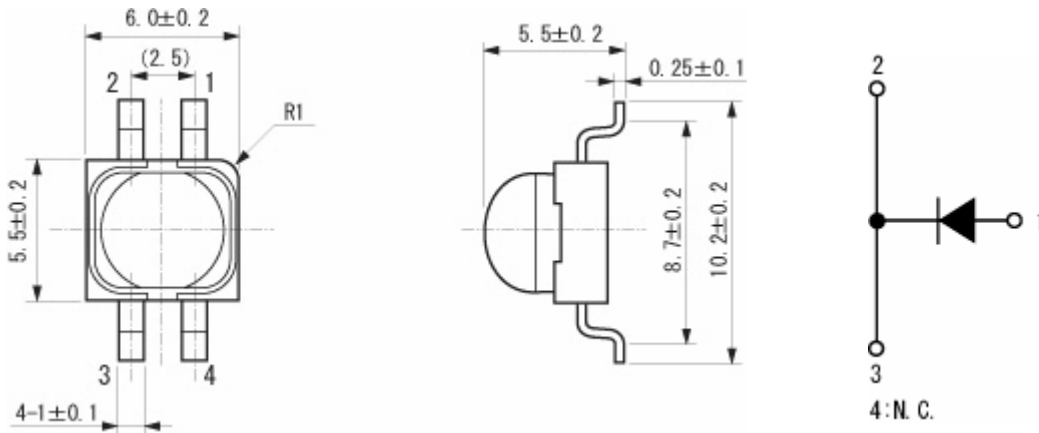
Technical Data



Package Dimensions

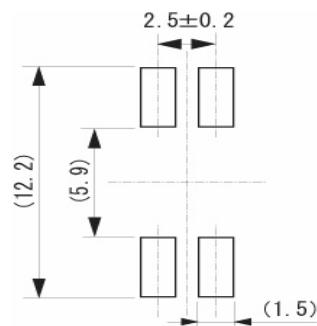
(Unit: mm)

Weight: (194)mg



Recommended Soldering Pattern

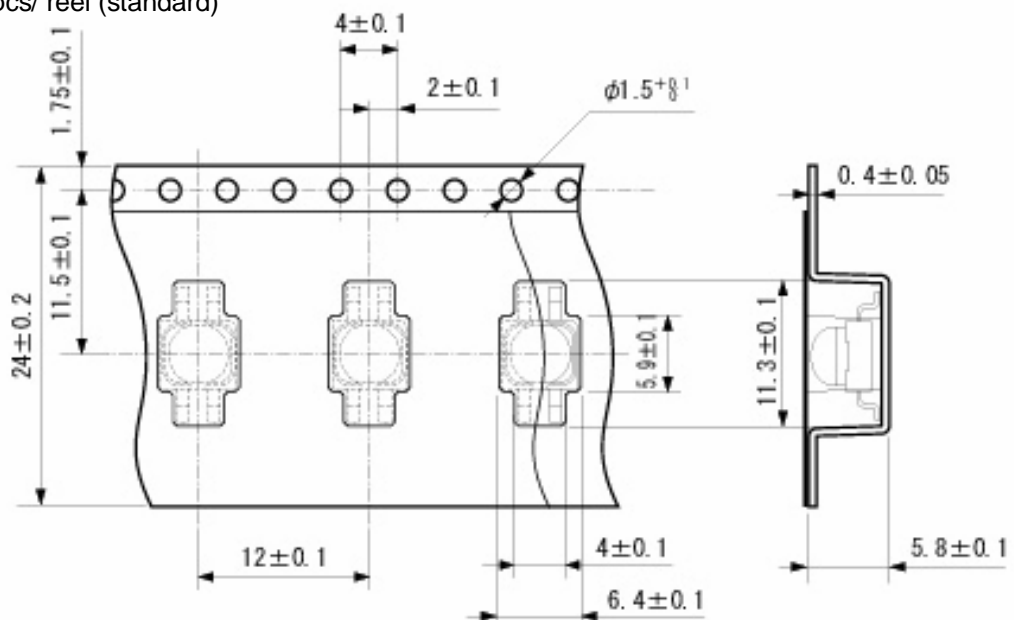
(Unit: mm)



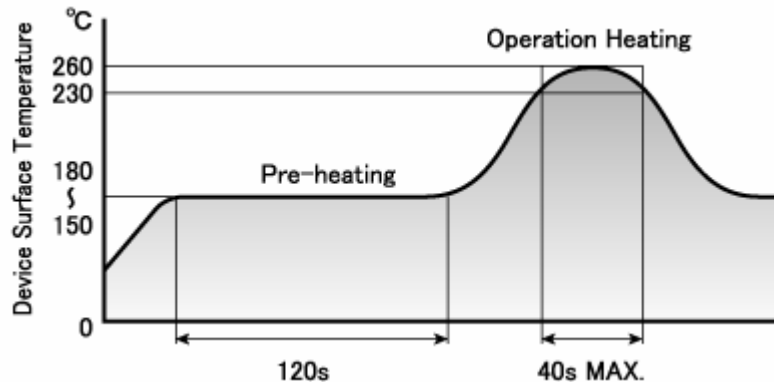
Taping Specification

(Unit: mm)

Quantity: 900pcs/ reel (standard)



Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized.

Manual Soldering Conditions

| | | |
|------------------------------|--------|--------------------|
| Iron tip temp. | 350 | (MAX.) (30 W Max.) |
| Soldering time and frequency | 3 s | (MAX.) |
| | 1 time | (MAX.) |

Handling Note

1. Handling of the Products

Mold resin on the backside of the products has adhesiveness. If dust or your hand is stuck to the backside, Please slowly remove the product from there. And if the backside is strongly pushed, it affects the characteristics and reliability. Please be careful in handling.

2. Dirt

If dirt sticks to the surface of lens, it affects the radiant intensity. Please don't touch the lens with bare hands. If dirt affects function, please wipe the dirt off carefully not to cause scratches on the lens with lens paper or the like. And if flux is stuck to the lens, please wipe the flux off carefully with alcohol-based cleaner.

3. Dew

When the temperature changes suddenly at high temperature and humidity, dew is generated. Because dew is likely to cause reduction in radiant intensity, failure to light up, deterioration of insulation and the like, please care. Because color of lens changes into milky color by rapid cooling at the conditions of high temperature and humidity, please care.

4. Freezing

When temperature is below 0 , water of dew and the like freezes. Because freezing is likely to cause reduction in radiant intensity, failure to light up, deterioration of insulation and the like, please care.

5. Strength

When mounting, assembling, cleaning the lens, storing the products and the like, please be careful not to apply mechanical stress and excessive vibration to products. They are likely to cause cracks, delamination and bending terminal. And they are likely to affect the characteristics and reliability badly.

6. Mechanical stress to terminals

When storing products and soldering, please be careful not to apply mechanical stress and excessive vibration to terminals. They are likely to cause cracks, delamination and bending terminal. And they are likely to affect the characteristics and reliability badly.

7. Backside

Dust is stuck to the backside easily on construction of this product. There is no problem on the characteristic even if dust is stuck to the backside. Please be careful not to wipe off forcibly and not to rub.

8. Moisture Absorption

If you use soldering with the over-specified humidity conditions, it affects the characteristics and reliability. Please use with the specified conditions.

9. Discoloration

This product might discolor by the heat of reflow and might change to yellowish. But there is no problem on the characteristic and reliability.

10. Application

Please stop to use by the applications that the breakdown and the wrong operation might influence the life or the human body.

11. Other

When there is a process of supersonic wave welding etc after mounting the product, there is a possibility of affecting on the reliability of junction part in package (junction part of die bonding and wire bonding). Please use after affirming beforehand there is no problem.

If this product is used excluding the content described to these specifications, we do not take any responsibility. If you use it excluding these ratings, please consult us beforehand.

Safety of Near-Infrared Rays

It is generally said that the near-infrared rays(870nm) used for this product is harmless to humans. But we can not say that direct rays to eyes are always safe as well as the visual light. Please pay attention when the product is used.

Reliability Testing Result

| Reliability Testing Result | Applicable Standard | Testing Conditions | Duration | Failure |
|---------------------------------|----------------------|---|--------------------|---------|
| Room Temp. Operating Life | EIAJED-4701/100(101) | Ta = 25 , If = 100mA | 1,000 h | 0/20 |
| | | Ta = 25 , IFRM = 1,000mA, (tw=100 μs, Duty=1/100) | 1,000 h | 0/20 |
| High Temp. Operating Life | EIAJED-4701/100(101) | Ta = 95 , If = 40mA | 1,000 h | 0/20 |
| Low Temp. Operating Life | EIAJED-4701/100(101) | Ta = -30 , If = 100mA | 1,000 h | 0/20 |
| Wet High Temp. Operating Life | EIAJED-4701/100(102) | Ta = 85 , 85%, If = 50mA | 1,000 h | 0/20 |
| Thermal Shock | EIAJED-4701/100(105) | Ta = -40 ~ 120 (each 15min.) | 1,000 cycles | 0/20 |
| High Temp. Storage Life | EIAJED-4701/200(201) | Ta = 120 | 1,000 h | 0/20 |
| Low Temp. Storage Life | EIAJED-4701/200(202) | Ta = -40 | 1,000 h | 0/20 |
| Resistance to Soldering Heat | EIAJED-4701/300(301) | (Pretreatment) Individual standard (Reflow Soldering) Pre-heating 180 120s Operating Heating 260 5s | Twice | 0/20 |
| Electric Static Discharge (ESD) | EIAJED-4701/300(304) | C = 100pF, R2 = 1.5K , ±2,000V | once each polarity | 0/10 |
| Vibration, Variable Frequency | EIAJED-4701/400(403) | 44.1m/s ² (4.5G), 20 ~ 500Hz, 20min, XYZ each direction | 2 h | 0/10 |
| Shock | EIAJED-4701/400(404) | 5000m/s ² (510G), 0.5ms, 6directions | 3 times | 0/10 |

Failure Criteria

| Items | Symbols | Conditions | Failure criteria |
|---------------------|----------------|---|--|
| Radiant Intensity | I _E | If Value of each product Radiant Intensity | Testing Min. Value < Initial Value x 0.5 |
| Forward Voltage | V _F | If Value of each product Forward Voltage | Testing Max. Value > Spec. Max. Value x 1.2 |
| Reverse Current | I _R | V _R = Maximum Rated Reverse Voltage V | Testing Max. Value > Spec. Max. Value x 2.5 |
| Cosmetic Appearance | - | - | Occurrence of notable decoloration, deformation and cracking |

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